

# TPS727 250-mA, Ultralow $I_Q$ , Fast Transient Response, RF Low-Dropout Linear Regulator

## 1 Features

- Very Low Dropout:
  - 65 mV Typical at 100 mA
  - 130 mV Typical at 200 mA
  - 163 mV Typical at 250 mA
- 2% Accuracy Over Load, Line, Temperature
- Ultralow  $I_Q$ : 7.9  $\mu$ A
- Excellent Load Transient Performance:  $\pm 50$  mV for 200 mA Loading and Unloading Transient
- Available in Fixed-Output Voltages From 0.9 V to 5 V Using Innovative Factory EEPROM Programming
- High PSRR: 70 dB at 1 kHz
- Stable with a 1.0- $\mu$ F Ceramic Capacitor
- Thermal Shutdown and Overcurrent Protection
- Available in 4-Ball, 0.4-mm Pitch Wafer-Level Chip Scale and 1.5-mm  $\times$  1.5-mm SON Packages

## 2 Applications

- Wireless Handsets, Smart Phones, PDAs
- MP3 Players and Other Handheld Products
- Wireless LAN, Bluetooth<sup>®</sup>, Zigbee<sup>®</sup>
- Remote Controls
- Portable Consumer Products

## 3 Description

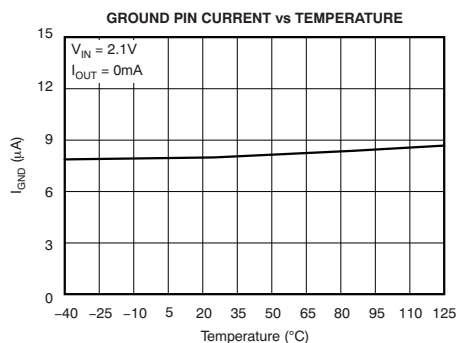
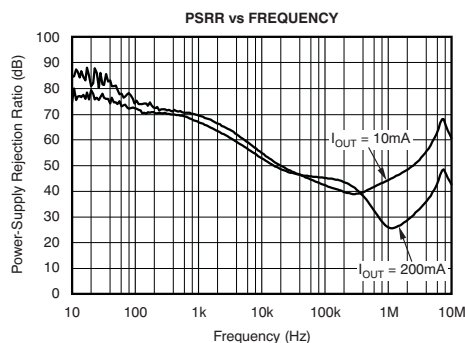
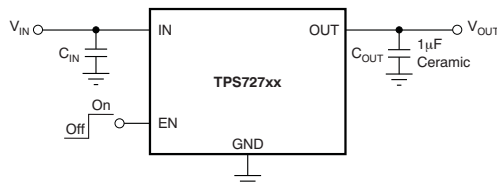
The TPS727 family of low-dropout (LDO) linear regulators are ultralow quiescent current LDOs with excellent line and ultra-fast load transient performance and are designed for power-sensitive applications. The LDO output voltage level is preset by the use of innovative factory EEPROM programming. A precision band-gap and error amplifier provides overall 2% accuracy over load, line, and temperature extremes. The TPS727 family is available in 1.5-mm  $\times$  1.5-mm SON and wafer chip-scale (WCSP) packages that make the devices ideal for handheld applications. This family of devices is fully specified over a temperature range of  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ .

### Device Information

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPS727xxDSE	WSON (6)	1.50 mm $\times$ 1.50 mm
TPS727xxYFF	DSBGA (4)	1.20 mm $\times$ 0.80 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

TYPICAL APPLICATION CIRCUIT



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### Changes from Revision E (September 2014) to Revision F Page

- Changed DSBGA body size in *Device Information* table .....

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### Changes from Revision D (February 2014) to Revision E Page

- Added TPS727105 to document .....
- Changed *terminal* to *pin* throughout document .....
- Updated Device Information table to current standards .....
- Changed Pin Configurations note .....
- Changed Pin Functions table: reordered table by pin name, added I/O column .....
- Updated Handling Ratings table to current standard .....
- Changed Thermal Information table: updated symbols .....
- Deleted *new generation* from first sentence of *Overview* section .....
- Added note to *Applications and Implementation* section .....

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### Changes from Revision C (January, 2011) to Revision D Page

- Changed format to meet latest data sheet standards; added new sections and moved existing sections .....
- Deleted pinout diagrams from front page; see *Pin Configurations and Functions* section. ....
- Changed Pin Configurations section and moved to *Pin Configurations and Functions* section .....
- Changed note in *Pin Configurations and Functions* section. ....
- Deleted Figure 26 and Figure 27 .....

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### Changes from Revision B (April, 2010) to Revision C Page

- Updated YFF front page pin drawing to show pin locations .....
- Revised Pin Configurations section .....
- Changed graph title for *Figure 6* .....

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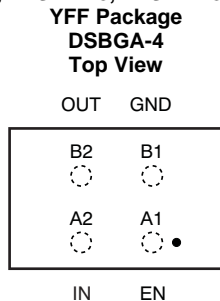
**7**

<b>Changes from Revision A (September, 2009) to Revision B</b>	<b>Page</b>
• Updated <i>Features</i> list .....	1
• Changed title of data sheet.....	1
• Changed footnote 2 to <i>Absolute Maximum Ratings</i> table .....	5
• Revised numerous specifications and parameters in <i>Electrical Characteristics</i> table .....	6
• Revised operating parameters for <a href="#">Figure 4</a> .....	7
• Replaced <a href="#">Figure 5</a> .....	7
• Added operating parameters to <a href="#">Figure 6</a> .....	7
• Updated <a href="#">Figure 9</a> .....	7

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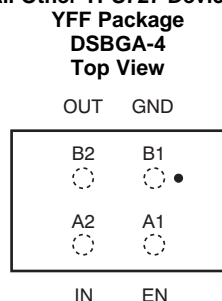
## 5 Pin Configurations and Functions

### TPS72715, TPS72718, TPS72728, TPS72748



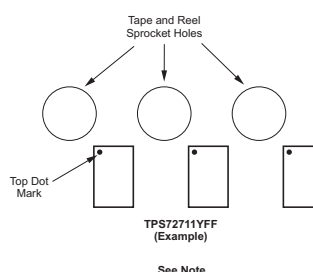
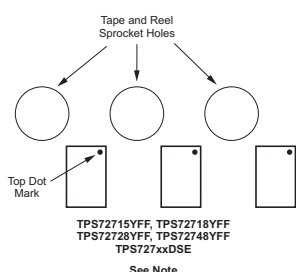
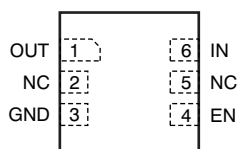
See note.

### All Other TPS727 Devices



See note.

### DSE Package 1,5mm × 1,5mm WSON-6 Top View



### NOTE

The **EN** pin is marked with a dot for the 1.5-V, 1.8-V, 2.8-V, and 4.8-V versions of the YFF package. The **GND** pin is marked with a dot for all other voltage versions of the YFF package. Refer to YFF0004 Package Outline page included at the end of this document for dimensions of the YFF package. On the package outline, the shaded box indicates the location of ball A1 and does not correlate to any marking on the topside of the physical package.

### Pin Functions

NAME	PIN		I/O	DESCRIPTION
	YFF	DSE		
EN	A1	4	I	Enable pin. Driving EN over 0.9 V turns on the regulator. Driving EN below 0.4 V puts the regulator into shutdown mode, thus reducing the operating current to 120 nA, nominal.
GND	B1	3	—	Ground pin.
IN	A2	6	I	Input pin. A small capacitor is needed from this pin to ground to assure stability. See <a href="#">Input and Output Capacitor Requirements</a> in the <i>Application Information</i> section for more details.
NC	—	2, 5	—	No connection. This pin can be tied to ground to improve thermal dissipation.
OUT	B2	1	O	Regulated output voltage pin. A small 1-μF ceramic capacitor is needed from this pin to ground to assure stability. See <a href="#">Input and Output Capacitor Requirements</a> in the <i>Application Information</i> section for more details.

## 6 Specifications

### 6.1 Absolute Maximum Ratings

at  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$  (unless otherwise noted); all voltages are with respect to GND<sup>(1)</sup>

	MIN	MAX	UNIT
Input voltage range, $V_{IN}$	-0.3	+6.0	V
Enable voltage range, $V_{EN}$	-0.3	+6.0 <sup>(2)</sup>	V
Output voltage range, $V_{OUT}$	-0.3	+6.0	V
Maximum output current, $I_{OUT}$	Internally limited		
Output short-circuit duration	Indefinite		
Operating junction temperature, $T_J$	-55	+150	$^\circ\text{C}$
Storage temperature, $T_{stg}$	-55	+150	$^\circ\text{C}$

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2)  $V_{EN}$  absolute maximum rating is  $V_{IN}$  or 6.0 V, whichever is less.

### 6.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	$\pm 2000$	V
	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	$\pm 500$	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating junction temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
$V_{IN}$	Input voltage	2		5.5	V
$I_{OUT}$	Output current	0		250	mA
$T_J$	Operating junction temperature range	-40		+125	$^\circ\text{C}$

### 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		TPS727		UNITS
		DSE (WSON)	YFF (DSBGA)	
		6 PINS	4 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	190.5	160	$^\circ\text{C}/\text{W}$
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	94.9	75	$^\circ\text{C}/\text{W}$
$R_{\theta JB}$	Junction-to-board thermal resistance	149.3	76	$^\circ\text{C}/\text{W}$
$\psi_{JT}$	Junction-to-top characterization parameter	6.4	3	$^\circ\text{C}/\text{W}$
$\psi_{JB}$	Junction-to-board characterization parameter	152.8	74	$^\circ\text{C}/\text{W}$
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance <sup>(2)</sup>	N/A	N/A	$^\circ\text{C}/\text{W}$

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).
- (2)  $\theta_{Jcbot}$  is not applicable because there is no thermal pad.

## 6.5 Electrical Characteristics

Over operating temperature range ( $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ),  $V_{IN} = V_{OUT(TYP)} + 0.3\text{ V}$  or  $2.0\text{ V}$ , whichever is greater;  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = 0.9\text{ V}$ , and  $C_{OUT} = 1.0\text{ }\mu\text{F}$  (unless otherwise noted). Typical values are at  $T_J = +25^\circ\text{C}$ .

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{IN}$	Input voltage range		2.0		5.5	V
$V_O$	Output voltage range		0.9		5.0	V
$V_{OUT}^{(1)}$	DC output accuracy	$T_J = +25^\circ\text{C}$	-2.5		+2.5	mV
		$V_{OUT} + 0.3\text{ V} \leq V_{IN} \leq 5.5\text{ V}$ , $0\text{ mA} \leq I_{OUT} \leq 200\text{ mA}$	-2.0%	$\pm 1.0\%$	+2.0%	
		$V_{OUT} + 0.3\text{ V} \leq V_{IN} \leq 5.5\text{ V}$ , $0\text{ mA} \leq I_{OUT} \leq 250\text{ mA}$		$\pm 1.0\%$		
$\Delta V_{OUT}$	Load transient	1 mA to 200 mA or 200 mA to 1 mA in 1 $\mu\text{s}$ , $C_{OUT} = 1\text{ }\mu\text{F}$		$\pm 50.0$		mV
		1 mA to 250 mA or 250 mA to 1 mA in 1 $\mu\text{s}$ , $C_{OUT} = 1\text{ }\mu\text{F}$		$\pm 65$		
$\Delta V_O/\Delta V_{IN}$	Line regulation	$V_{OUT(NOM)} + 0.3\text{ V} \leq V_{IN} \leq 5.5\text{ V}$ , $I_{OUT} = 10\text{ mA}$		8		$\mu\text{V/V}$
$\Delta V_O/\Delta I_{OUT}$	Load regulation	$0\text{ mA} \leq I_{OUT} \leq 250\text{ mA}$		20		$\mu\text{V/mA}$
$V_{DO}$	Dropout voltage <sup>(2)</sup>	$V_{IN} = 0.98 \times V_{OUT(NOM)}$ , $I_{OUT} = 10\text{ mA}$		6.5		mV
		$V_{IN} = 0.98 \times V_{OUT(NOM)}$ , $I_{OUT} = 50\text{ mA}$		32.5		
		$V_{IN} = 0.98 \times V_{OUT(NOM)}$ , $I_{OUT} = 100\text{ mA}$		65		
		$V_{IN} = 0.98 \times V_{OUT(NOM)}$ , $I_{OUT} = 200\text{ mA}$		130	200	
		$V_{IN} = 0.98 \times V_{OUT(NOM)}$ , $I_{OUT} = 250\text{ mA}$		162.5		
$I_{CL}$	Output current limit	$V_{OUT} = 0.9 \times V_{OUT(NOM)}$	300	400	550	mA
$I_{GND}$	Ground pin current	$I_{OUT} = 0\text{ mA}$ , $T_J = -40^\circ\text{C}$ to $+125^\circ\text{C}$		7.9	12	$\mu\text{A}$
		$I_{OUT} = 200\text{ mA}$		110		
		$I_{OUT} = 250\text{ mA}$		130		
$I_{SHDN}$	Shutdown current ( $I_{GND}$ )	$V_{EN} \leq 0.4\text{ V}$ , $V_{IN} = 2\text{ V}$ , $T_J = +25^\circ\text{C}$		0.12		$\mu\text{A}$
		$V_{EN} \leq 0.4\text{ V}$ , $2.0\text{ V} < V_{IN} \leq 4.5\text{ V}$ , $T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$		0.55	2	
PSRR	Power-supply rejection ratio	$V_{IN} = 2.3\text{ V}$ , $V_{OUT} = 1.8\text{ V}$ , $I_{OUT} = 10\text{ mA}$	f = 10 Hz		85	dB
			f = 100 Hz		75	
			f = 1 kHz		70	
			f = 10 kHz		55	
			f = 100 kHz		40	
			f = 1 MHz		45	
$V_N$	Output noise voltage	BW = 100 Hz to 100 kHz, $V_{IN} = 2.1\text{ V}$ , $V_{OUT} = 1.8\text{ V}$ , $I_{OUT} = 10\text{ mA}$		33.5		$\mu\text{V}_{RMS}$
$t_{STR}$	Startup time <sup>(3)</sup>	$C_{OUT} = 1.0\text{ }\mu\text{F}$ , $0 \leq I_{OUT} \leq 250\text{ mA}$		100		$\mu\text{s}$
$V_{HI}$	Enable pin high (enabled)		0.9		$V_{IN}$	V
$V_{LO}$	Enable pin low (disabled)		0		0.4	V
$I_{EN}$	Enable pin current	EN = 5.5 V		40	500	nA
UVLO	Undervoltage lock-out	$V_{IN}$ rising	1.85	1.90	1.95	V
$T_{SD}$	Thermal shutdown temperature	Shutdown, temperature increasing		+160		$^\circ\text{C}$
		Reset, temperature decreasing		+140		
$T_J$	Operating junction temperature		-40		+125	$^\circ\text{C}$

(1) The output voltage is programmed at the factory.

(2)  $V_{DO}$  is measured for devices with  $V_{OUT(NOM)} \geq 2.35\text{ V}$  so that  $V_{IN} \geq 2.3\text{ V}$ .

(3) Startup time: time from EN assertion to  $0.98 \times V_{OUT(NOM)}$ .

### 6.6 Typical Characteristics

Over operating temperature range ( $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ),  $V_{IN} = V_{OUT(TYP)} + 0.3\text{ V}$  or  $2.0\text{ V}$ , whichever is greater;  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = V_{IN}$ , and  $C_{OUT} = 1.0\ \mu\text{F}$  (unless otherwise noted). Typical values are at  $T_J = +25^\circ\text{C}$ .

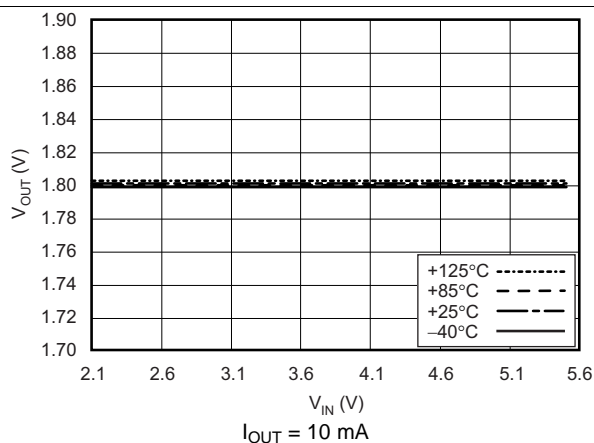


Figure 1. Line Regulation (TPS72718)

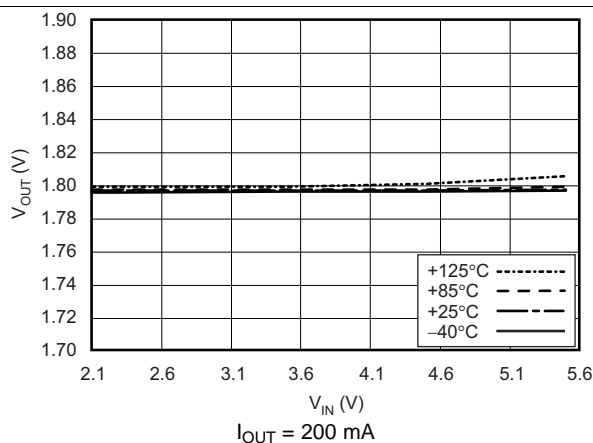


Figure 2. Line Regulation (TPS72718)

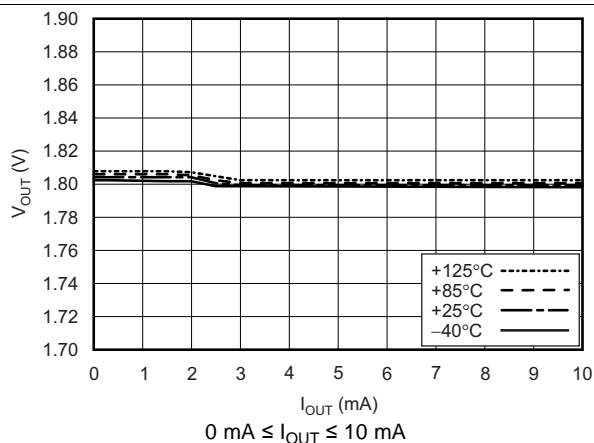


Figure 3. Load Regulation Under Light Loads (TPS72718)

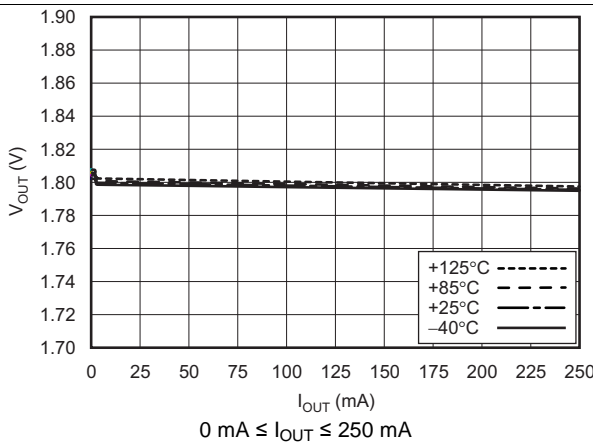


Figure 4. Load Regulation (TPS72718)

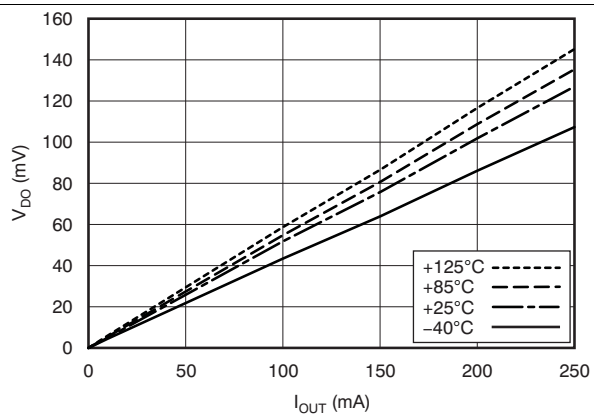


Figure 5. Dropout Voltage vs Output Current (TPS72750)

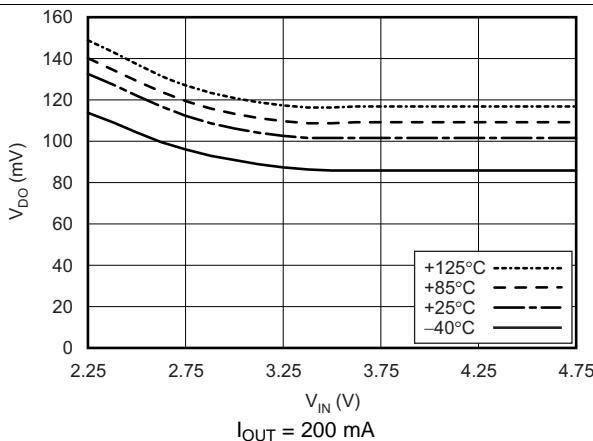


Figure 6. Dropout Voltage vs Input Voltage

### Typical Characteristics (continued)

Over operating temperature range ( $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ),  $V_{IN} = V_{OUT(TYP)} + 0.3\text{ V}$  or  $2.0\text{ V}$ , whichever is greater;  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = V_{IN}$ , and  $C_{OUT} = 1.0\ \mu\text{F}$  (unless otherwise noted). Typical values are at  $T_J = +25^\circ\text{C}$ .

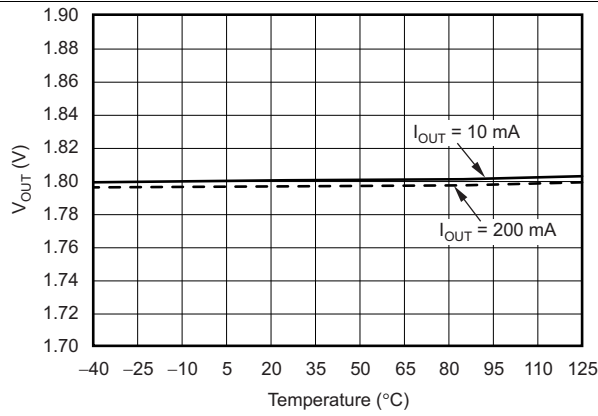


Figure 7. Output Voltage vs Temperature (TPS72718)

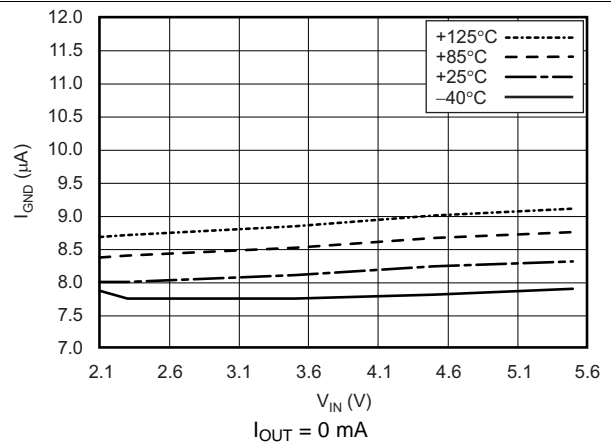


Figure 8. Ground Pin Current vs Input Voltage (TPS72718)

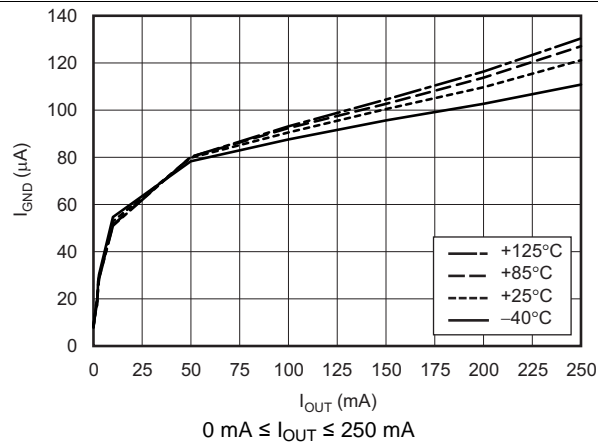


Figure 9. Ground Pin Current vs Load (TPS72718)

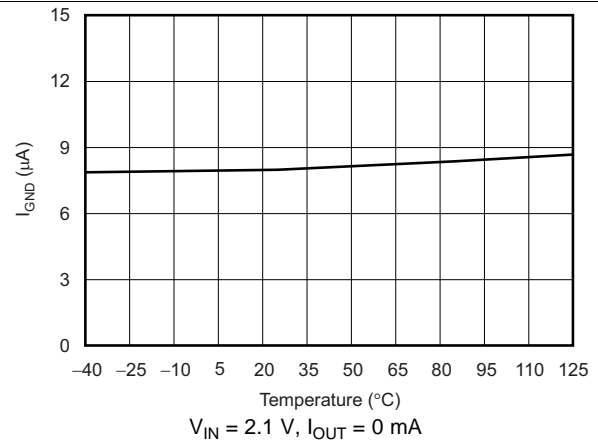


Figure 10. Ground Pin Current vs Temperature (TPS72718)

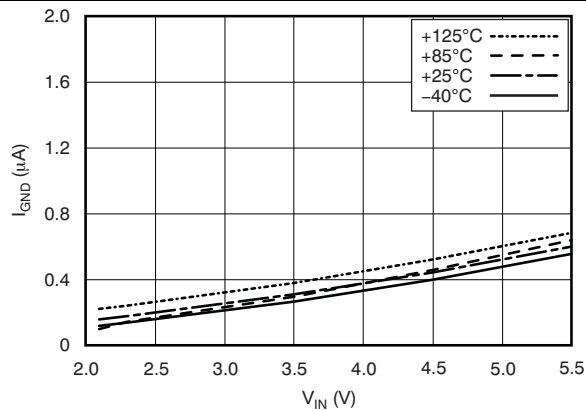


Figure 11. Shutdown Current vs Input Voltage (TPS72718)

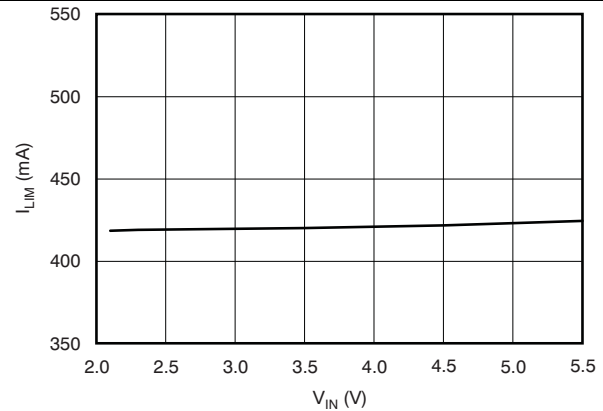


Figure 12. Current Limit vs Input Voltage (TPS72718)



Typical Characteristics (continued)

Over operating temperature range ( $T_J = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ),  $V_{IN} = V_{OUT(TYP)} + 0.3\text{ V}$  or  $2.0\text{ V}$ , whichever is greater;  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = V_{IN}$ , and  $C_{OUT} = 1.0\ \mu\text{F}$  (unless otherwise noted). Typical values are at  $T_J = +25^{\circ}\text{C}$ .

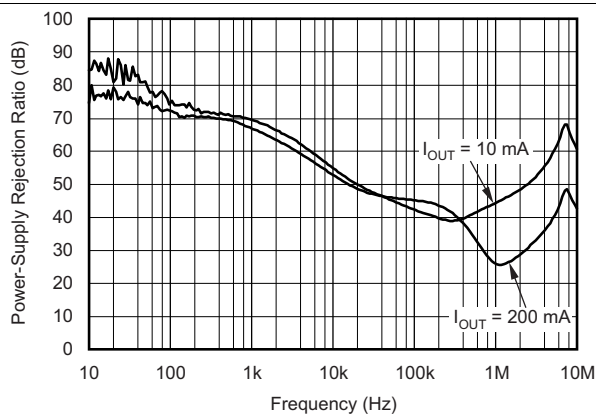


Figure 13. PSRR vs Frequency ( $V_{IN} - V_{OUT} = 0.5\text{ V}$ , TPS72718)

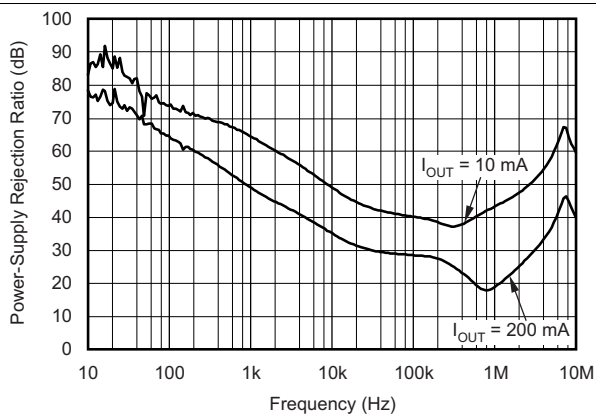


Figure 14. PSRR vs Frequency ( $V_{IN} - V_{OUT} = 0.3\text{ V}$ , TPS72718)

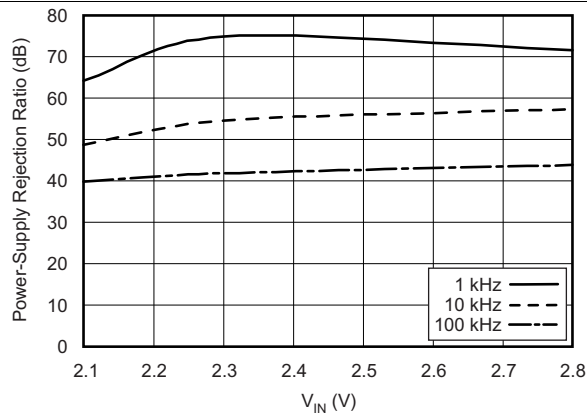


Figure 15. PSRR vs Input Voltage (TPS72718)

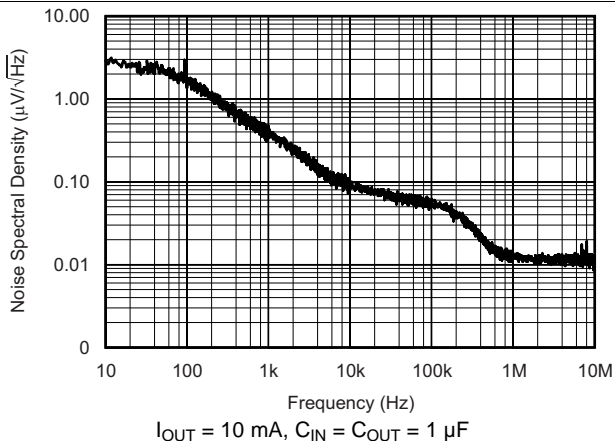


Figure 16. Output Spectral Noise Density vs Output Voltage (TPS72718)

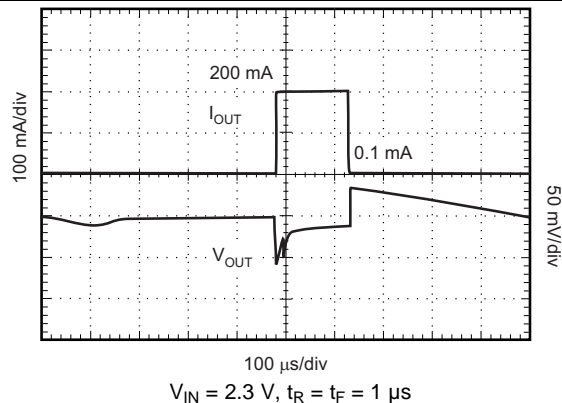


Figure 17. Load Transient Response: 0.1 mA to 200 mA (TPS72718)

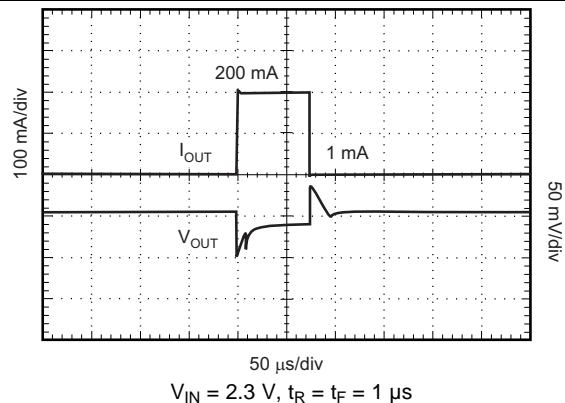
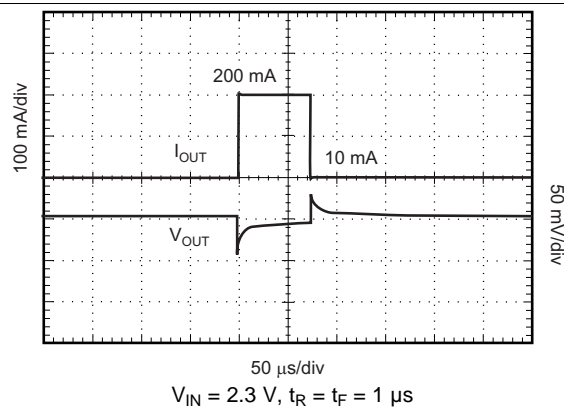


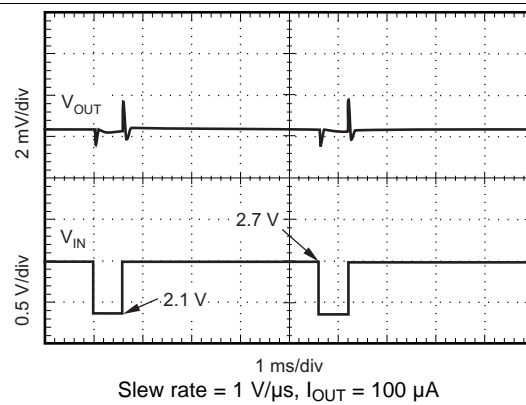
Figure 18. Load Transient Response: 1 mA to 200 mA (TPS72718)

**Typical Characteristics (continued)**

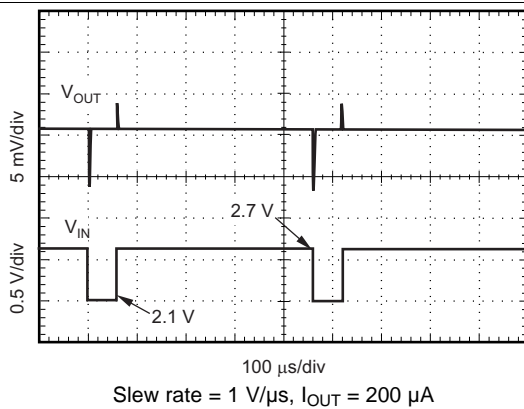
Over operating temperature range ( $T_J = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ),  $V_{IN} = V_{OUT(TYP)} + 0.3\text{ V}$  or  $2.0\text{ V}$ , whichever is greater;  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = V_{IN}$ , and  $C_{OUT} = 1.0\text{ }\mu\text{F}$  (unless otherwise noted). Typical values are at  $T_J = +25^{\circ}\text{C}$ .



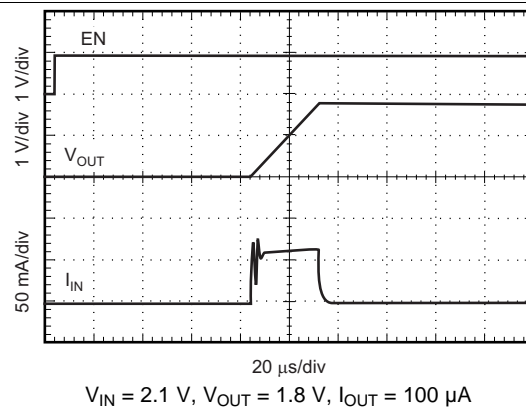
**Figure 19. Load Transient Response: 10 mA to 200 mA (TPS72718)**



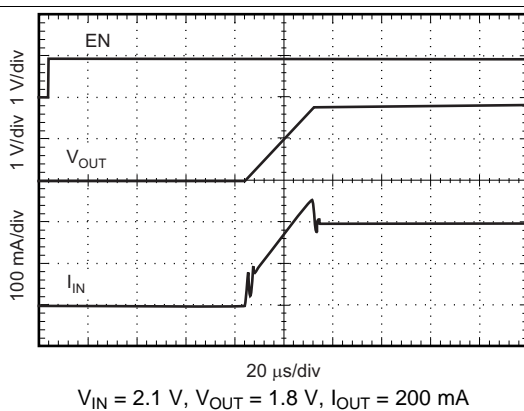
**Figure 20. Line Transient Response (TPS72718)**



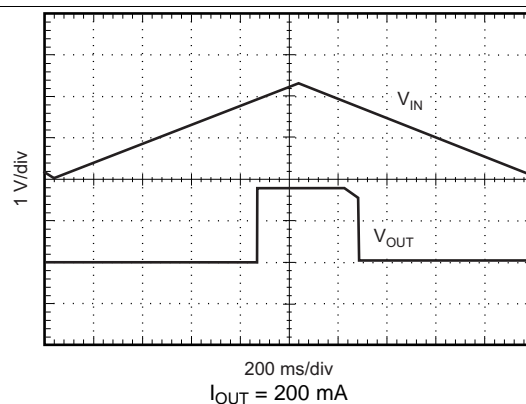
**Figure 21. Line Transient Response (TPS72718)**



**Figure 22.  $V_{IN}$  Inrush Current (TPS72718)**



**Figure 23.  $V_{IN}$  Inrush Current (TPS72718)**



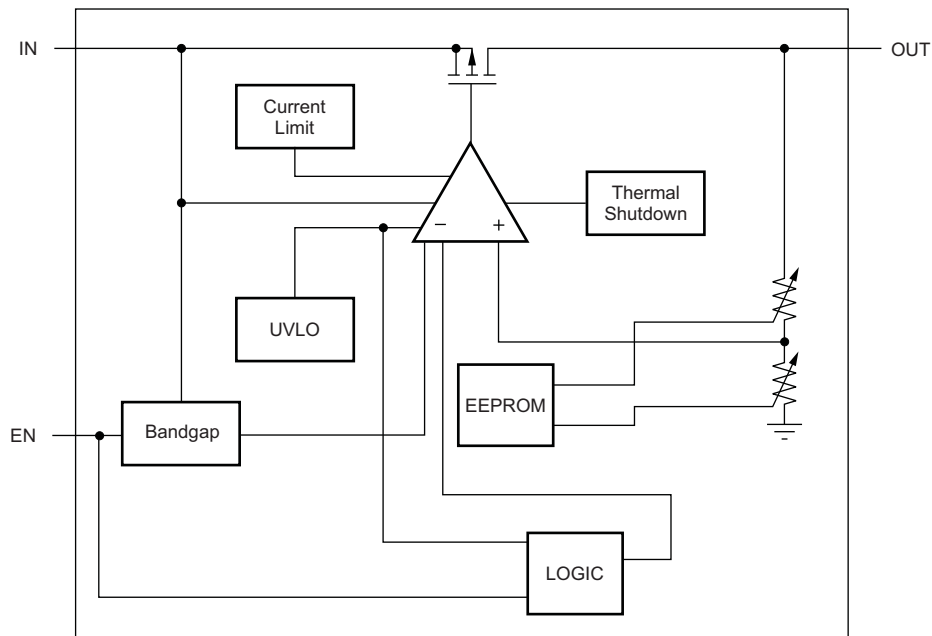
**Figure 24.  $V_{IN}$  Ramp Up, Ramp Down Response (TPS72718)**

## 7 Detailed Description

### 7.1 Overview

The TPS727 devices belong to a family of LDO regulators that consume extremely low quiescent current while simultaneously delivering excellent PSRR with very little headroom ( $V_{IN} - V_{OUT}$  differential voltage), and very good transient response. These features, combined with low noise without a noise reduction pin in an ultrasmall package, make these devices ideal for portable applications. This family of regulators offers sub-band-gap output voltages, current limit and thermal protection, and is fully specified from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

### 7.2 Functional Block Diagram



### 7.3 Feature Description

#### 7.3.1 Internal Current Limit

The TPS727 internal current limit helps protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current that is largely independent of output voltage. In such a case, the output voltage is not regulated and is  $V_{OUT} = I_{LIMIT} \times R_{LOAD}$ . The PMOS pass transistor dissipates  $(V_{IN} - V_{OUT}) \times I_{LIMIT}$  until thermal shutdown is triggered and the device is turned off. As the device cools down, it is turned on by the internal thermal shutdown circuit. If the fault condition continues, the device cycles between current limit and thermal shutdown. See the [Thermal Protection](#) section for more details.

The PMOS pass element in the TPS727 has a built-in body diode that conducts current when the voltage at the OUT pin exceeds the voltage at the IN pin. This current is not limited, so if extended reverse voltage operation is anticipated, external limiting to 5% of rated output current is recommended.

#### 7.3.2 Soft Start

The startup current is given by [Equation 1](#):

$$I_{SOFT\ START} \text{ (mA)} = C_{OUT} \text{ (\mu F)} \times 0.07 \text{ (V/\mu s)} + I_{LOAD} \text{ (mA)} \quad (1)$$

[Equation 1](#) shows that soft-start current is directly proportional to  $C_{OUT}$ .

The output voltage ramp rate is independent of  $C_{OUT}$  and load current, and has a typical value of 0.07 V/ $\mu\text{s}$ .

## Feature Description (continued)

The TPS727 automatically adjusts the soft-start current to supply both the load current and the  $C_{OUT}$  charge current. For example, if  $I_{LOAD} = 0$  mA upon enabling the LDO,  $I_{SOFT\ START} = 1\ \mu\text{F} \times 0.07\ \text{V}/\mu\text{s} + 0\ \text{mA} = 70\ \text{mA}$ , the current that charges the output capacitor.

If  $I_{LOAD} = 200$  mA,  $I_{SOFT\ START} = 1\ \mu\text{F} \times 0.07\ \text{V}/\mu\text{s} + 200\ \text{mA} = 270\ \text{mA}$ , the current required for charging output capacitor and supplying the load current.

If the output capacitor and load are increased such that the soft-start current exceeds the output current limit, the current is clamped at the typical current limit of 400 mA. For example, if  $C_{OUT} = 10\ \mu\text{F}$  and  $I_{OUT} = 200$  mA,  $10\ \mu\text{F} \times 0.07\ \text{V}/\mu\text{s} + 200\ \text{mA} = 900\ \text{mA}$  is not supplied. Instead, the current is clamped at 400 mA.

### 7.3.3 Shutdown

The enable pin (EN) is active high and is compatible with standard and low voltage, TTL-CMOS levels. When shutdown capability is not required, EN can be connected to the IN pin.

### 7.3.4 Dropout Voltage

The TPS727 uses a PMOS pass transistor to achieve low dropout. When  $(V_{IN} - V_{OUT})$  is less than the dropout voltage ( $V_{DO}$ ), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the  $R_{DS(ON)}$  of the PMOS pass element.  $V_{DO}$  approximately scales with output current because the PMOS device functions like a resistor in dropout.

As with any linear regulator, PSRR and transient response are degraded as  $(V_{IN} - V_{OUT})$  approaches dropout. This effect is illustrated in [Figure 15](#) in the [Typical Characteristics](#) section.

### 7.3.5 Undervoltage Lock-out (UVLO)

The TPS727 uses an undervoltage lock-out circuit that keeps the output shut off until the input voltage reaches the UVLO threshold voltage.

### 7.3.6 Thermal Protection

Thermal protection disables the output when the junction temperature rises to approximately +160°C, allowing the device to cool. When the junction temperature cools to approximately +140°C the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits the dissipation of the regulator, protecting it from damage as a result of overheating.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heatsink. For reliable operation, limit junction temperature to +125°C maximum. To estimate the margin of safety in a complete design (including heatsink), increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions. For good reliability, thermal protection triggers at least +35°C above the maximum expected ambient condition of a particular application. This configuration produces a worst-case junction temperature of +125°C at the highest expected ambient temperature and worst-case load.

The internal protection circuitry of the TPS727 is designed to protect against overload conditions. This circuitry is not intended to replace proper heatsinking. Continuously running the TPS727 into thermal shutdown degrades device reliability.

## 7.4 Device Functional Modes

### 7.4.1 Operation with EN Control

Driving EN over 0.9 V turns on the regulator. Driving EN below 0.4 V puts the regulator into shutdown mode, thus reducing the operating current to 120 nA, nominal.

## 8 Applications and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

The TPS727 family of low-dropout (LDO) linear regulators are ultralow quiescent current LDOs with excellent line and ultra-fast load transient performance and are designed for power-sensitive applications.

### 8.2 Typical Application

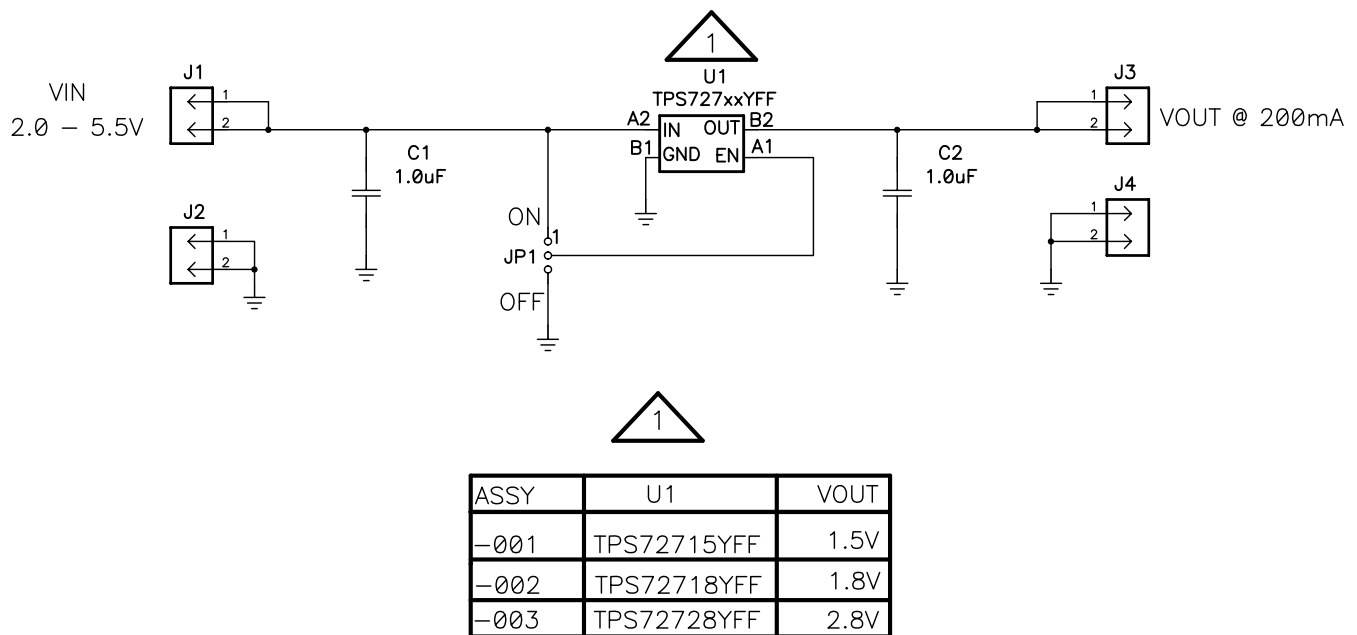


Figure 25. TPS72718YFF 2.5 V<sub>IN</sub> to 1.8 V<sub>OUT</sub> at 200 mA Schematic

#### 8.2.1 Design Requirements

##### 8.2.1.1 Input and Output Capacitor Requirements

Although an input capacitor is not required for stability, good analog design practice is to connect a 0.1-µF to 1.0-µF low equivalent series resistance (ESR) capacitor across the IN pin and GND input of the regulator. This capacitor counteracts reactive input sources and improves transient response, noise rejection, and ripple rejection. A higher-value capacitor may be necessary if large, fast rise-time load transients are anticipated, or if the device is not located close to the power source. If source impedance is not sufficiently low, a 0.1-µF input capacitor may be necessary to ensure stability.

The TPS727 is designed to be stable with standard ceramic capacitors with values of 1.0 µF or larger at the output. X5R- and X7R-type capacitors are best because they have minimal variation in value and ESR over temperature. Maximum ESR must be less than 200 mΩ.

##### 8.2.1.2 Transient Response

As with any regulator, increasing the size of the output capacitor reduces over- and undershoot magnitude but increases duration of the transient response.

## Typical Application (continued)

### 8.2.2 Detailed Design Procedure

Select the desired device based on the output voltage.

Provide an input supply with adequate headroom to include dropout and output current to account for the GND pin current and to power the load.

Select adequate input and output capacitors.

The startup current is given by [Equation 2](#):

$$I_{\text{SOFT START}} \text{ (mA)} = C_{\text{OUT}}(\mu\text{F}) \times 0.07 \text{ (V}/\mu\text{s}) + I_{\text{LOAD}} \text{ (mA)} \quad (2)$$

[Equation 2](#) shows that soft-start current is directly proportional to  $C_{\text{OUT}}$ .

The output voltage ramp rate is independent of  $C_{\text{OUT}}$  and load current and has a typical value of 0.07 V/ $\mu\text{s}$ .

The TPS727 automatically adjusts the soft-start current to supply both the load current and the  $C_{\text{OUT}}$  charge current. For example, if  $I_{\text{LOAD}} = 0$  mA upon enabling the LDO,  $I_{\text{SOFT START}} = 1 \mu\text{F} \times 0.07 \text{ V}/\mu\text{s} + 0 \text{ mA} = 70 \text{ mA}$ , the current that charges the output capacitor.

If  $I_{\text{LOAD}} = 200$  mA,  $I_{\text{SOFT START}} = 1 \mu\text{F} \times 0.07 \text{ V}/\mu\text{s} + 200 \text{ mA} = 270 \text{ mA}$ , the current required for charging output capacitor and supplying the load current.

If the output capacitor and load are increased such that the soft-start current exceeds the output current limit, the current is clamped at the typical current limit of 400 mA. For example, if  $C_{\text{OUT}} = 10 \mu\text{F}$  and  $I_{\text{OUT}} = 200$  mA,  $10 \mu\text{F} \times 0.07 \text{ V}/\mu\text{s} + 200 \text{ mA} = 900 \text{ mA}$  is not supplied. Instead, the current is clamped at 400 mA.

Typical Application (continued)

8.2.3 Application Curves

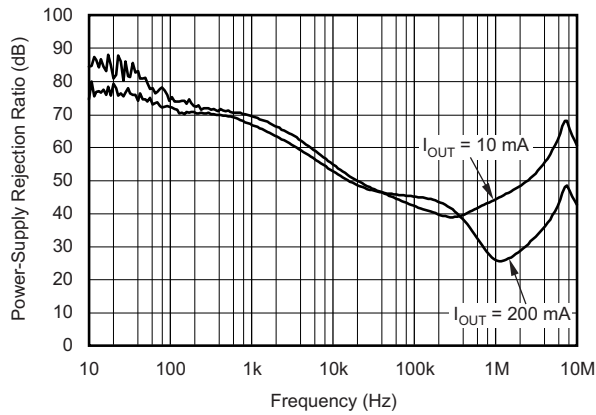


Figure 26. PSRR vs Frequency ( $V_{IN} - V_{OUT} = 0.5\text{ V}$ , TPS72718)



$I_{OUT} = 10\text{ mA}$ ,  $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$

Figure 27. Output Spectral Noise Density vs Output Voltage (TPS72718)

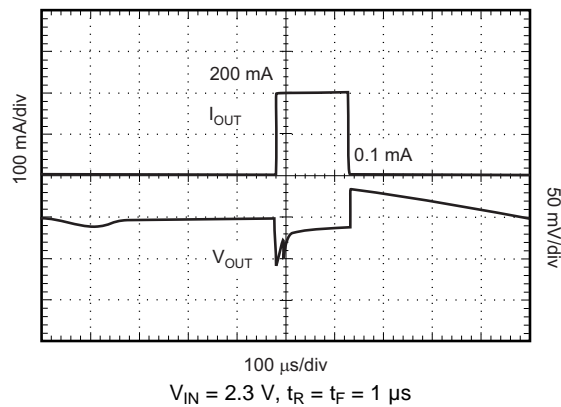


Figure 28. Load Transient Response: 0.1 mA to 200 mA (TPS72718)

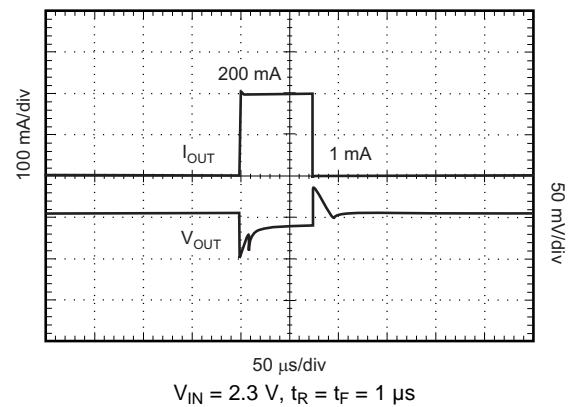


Figure 29. Load Transient Response: 1 mA to 200 mA (TPS72718)

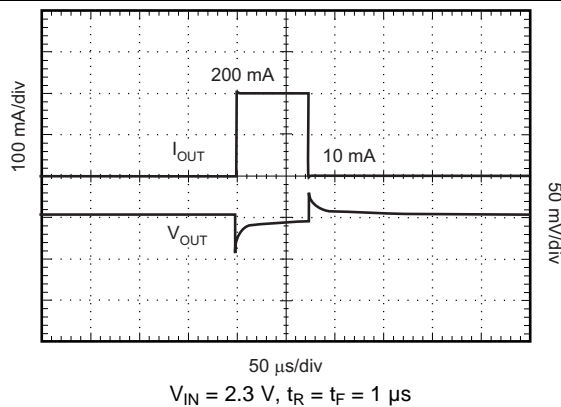


Figure 30. Load Transient Response: 10 mA to 200 mA (TPS72718)

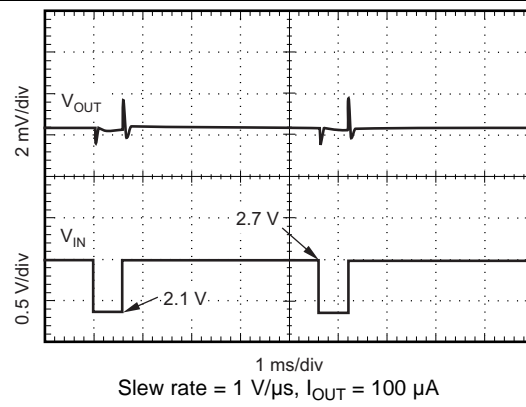
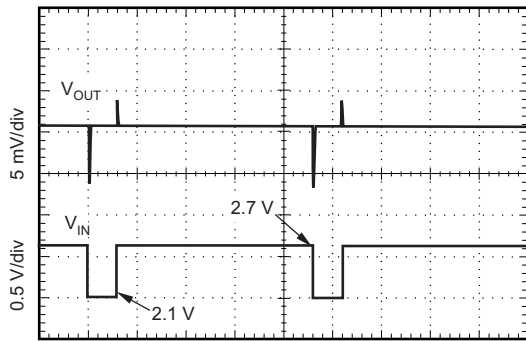


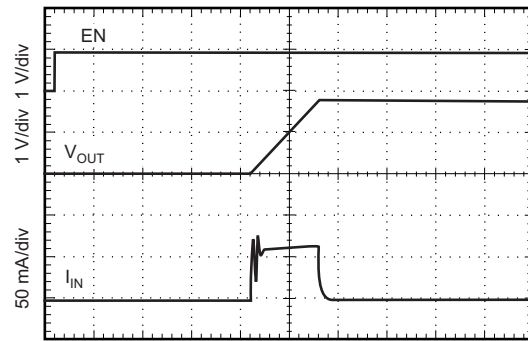
Figure 31. Line Transient Response (TPS72718)

**Typical Application (continued)**



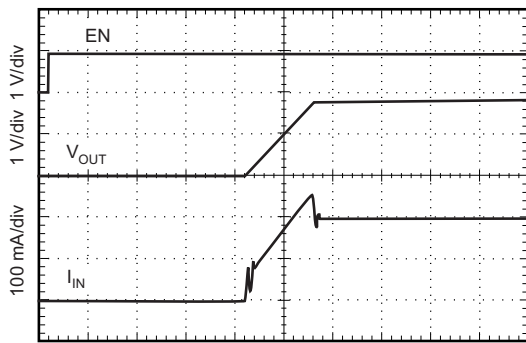
100  $\mu$ s/div  
Slew rate = 1 V/ $\mu$ s,  $I_{OUT}$  = 200  $\mu$ A

**Figure 32. Line Transient Response (TPS72718)**



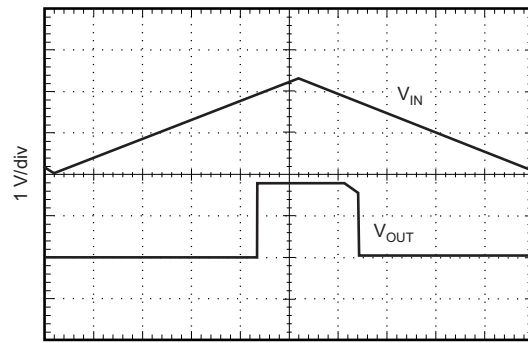
20  $\mu$ s/div  
 $V_{IN}$  = 2.1 V,  $V_{OUT}$  = 1.8 V,  $I_{OUT}$  = 100  $\mu$ A

**Figure 33.  $V_{IN}$  Inrush Current (TPS72718)**



20  $\mu$ s/div  
 $V_{IN}$  = 2.1 V,  $V_{OUT}$  = 1.8 V,  $I_{OUT}$  = 200 mA

**Figure 34.  $V_{IN}$  Inrush Current (TPS72718)**



200 ms/div  
 $I_{OUT}$  = 200 mA

**Figure 35.  $V_{IN}$  Ramp Up, Ramp Down Response (TPS72718)**



### 8.3 Do's and Don'ts

Do place at least one 1.0- $\mu$ F ceramic capacitor as close as possible to the OUT pin of the regulator.

Do not place the output capacitor more than 10 mm away from the regulator.

For DSE devices, do tie the NC pins to ground to improve thermal dissipation.

Do connect a 0.1- $\mu$ F to 1.0- $\mu$ F low equivalent series resistance (ESR) capacitor across the IN pin and GND input of the regulator.

Do not exceed the absolute maximum ratings.

## 9 Power-Supply Recommendations

These devices are designed to operate from an input voltage supply range between 2.0 V and 5.5 V. The input voltage range provides adequate headroom in order for the device to have a regulated output. This input supply must be well regulated. If the input supply is noisy, additional input capacitors with low ESR can help improve the output noise performance.

## 10 Layout

### 10.1 Layout Guidelines

#### 10.1.1 Board Layout Recommendations to Improve PSRR and Noise Performance

To improve ac performance (such as PSRR, output noise, and transient response), TI recommends that the board be designed with separate ground planes for  $V_{IN}$  and  $V_{OUT}$ , with the ground plane connected only at the GND pin of the device. In addition, the ground connection for the output capacitor must be connected directly to the GND pin of the device. High ESR capacitors may degrade PSRR.

#### 10.1.2 Power Dissipation

The ability to remove heat from the die is different for each package type, presenting different considerations in the printed circuit board (PCB) layout. The PCB area around the device that is free of other components moves the heat from the device to the ambient air. Performance data for JEDEC low- and high-K boards are given in the [Thermal Information](#) table. Using heavier copper increases the effectiveness in removing heat from the device. The addition of plated through-holes to heat-dissipating layers also improves the heatsink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation ( $P_D$ ) is equal to the product of the output current times the voltage drop across the output pass element ( $V_{IN}$  to  $V_{OUT}$ ), as shown in [Equation 3](#):

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (3)$$

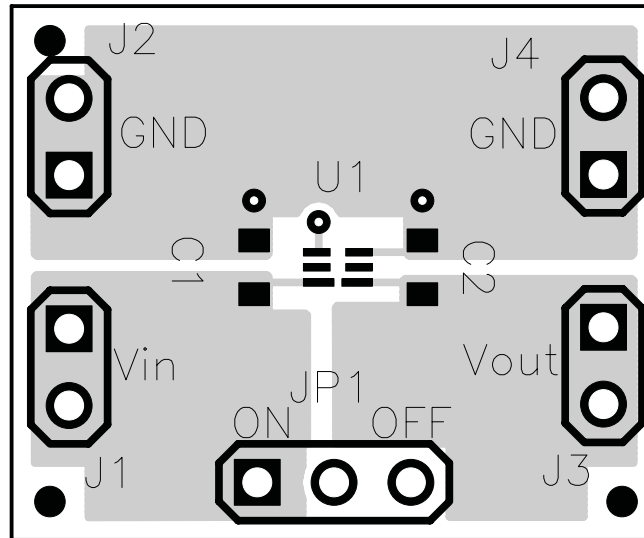
#### 10.1.3 Package Mounting

Solder pad footprint recommendations and recommended land patterns are attached to the end of this document.

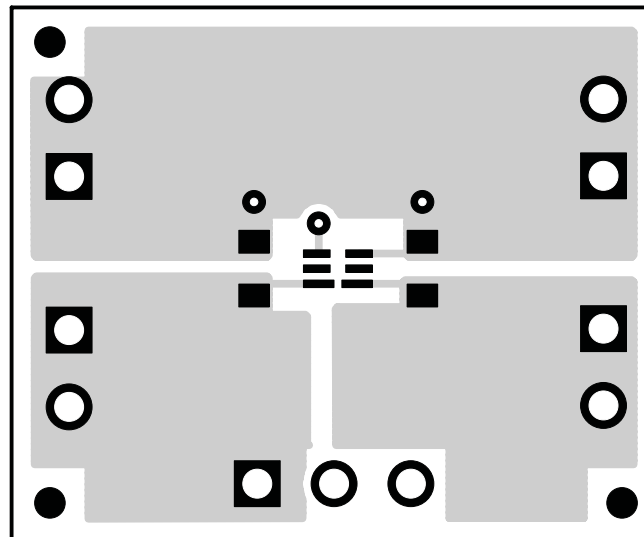
## 10.2 Layout Example

### 10.2.1 DSE EVM Board Layout

This section provides the TPS727xxDSEEM-406 board layout and illustrations.



**Figure 36. Top Layer Assembly**



**Figure 37. Top Layer Routing**

Layout Example (continued)

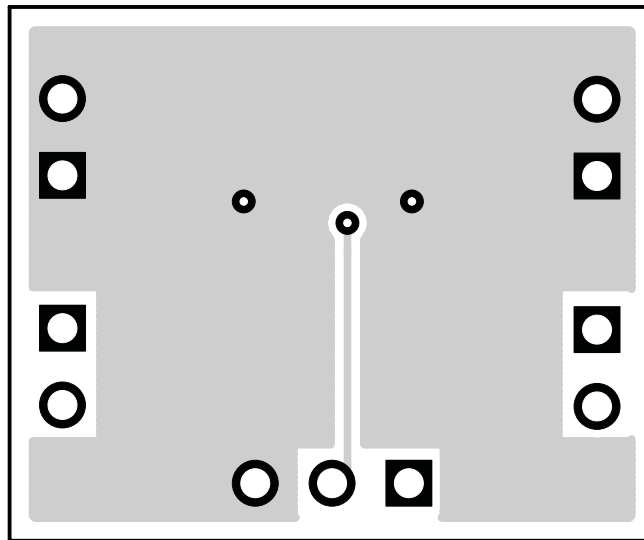


Figure 38. Bottom Layer Routing

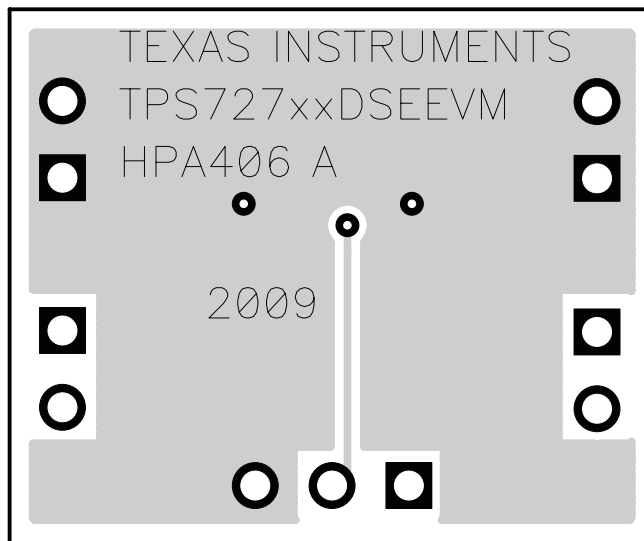
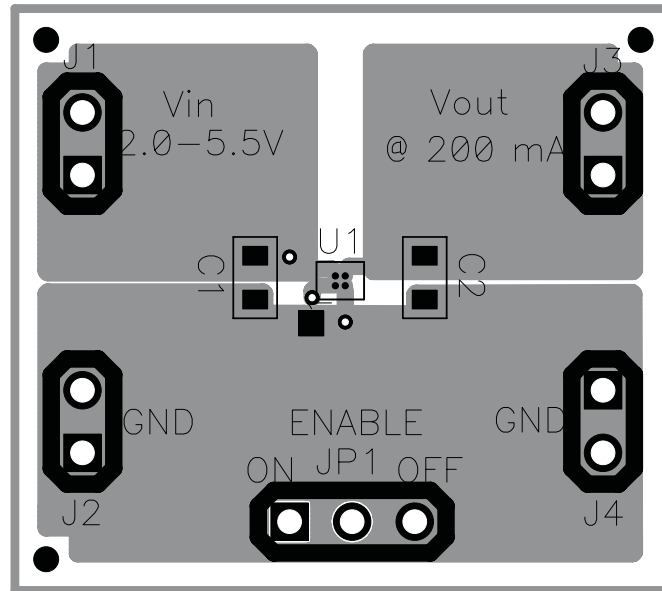


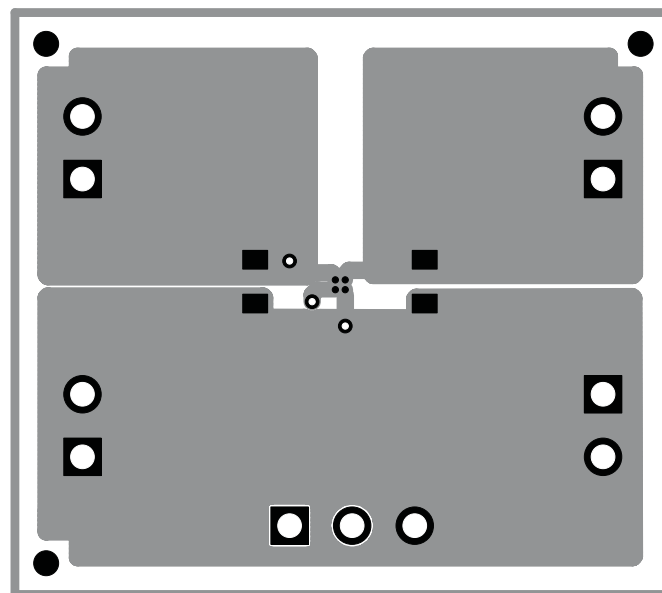
Figure 39. Bottom Layer Assembly

**Layout Example (continued)**
**10.2.2 YFF EVM Board Layout**

This section provides the TPS727xxYFFEVM-407 board layout and illustrations.



**Figure 40. Top Layer Assembly**



**Figure 41. Top Layer Routing**

Layout Example (continued)

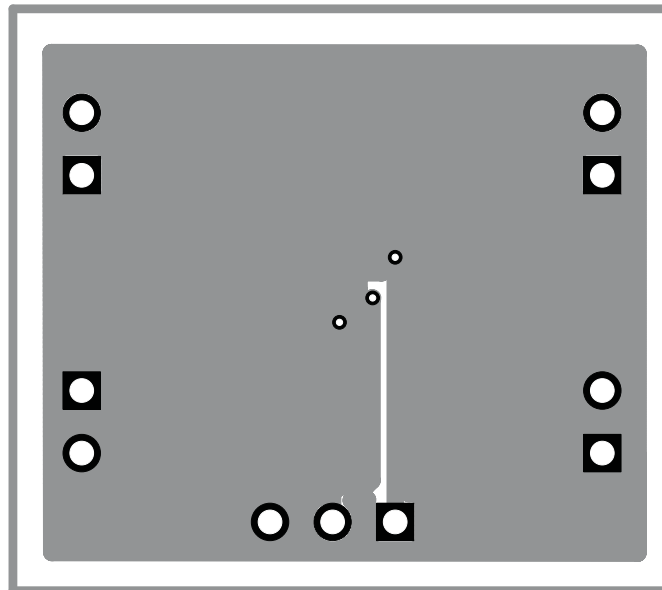


Figure 42. Bottom Layer Routing

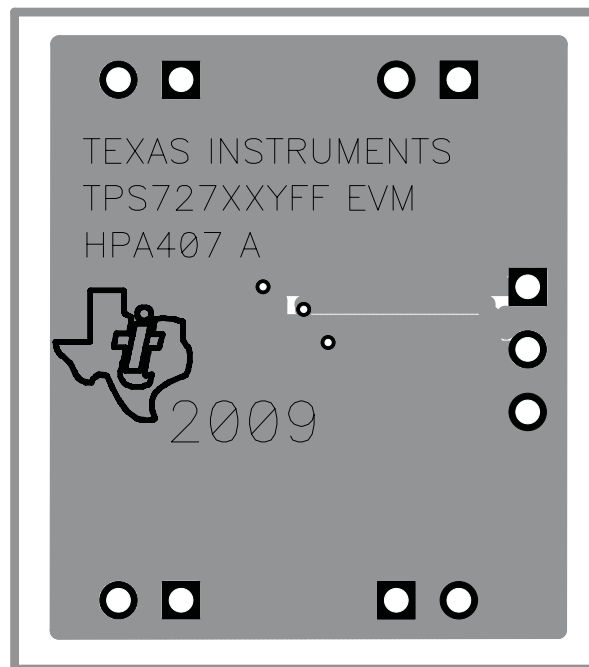


Figure 43. Bottom Layer Assembly

## 11 Device and Documentation Support

### 11.1 Documentation Support

#### 11.1.1 Related Documentation

Application report [SLAA414](#), *LDO PSRR Measurement Simplified*.

Application report [SLAA412](#), *LDO Noise Demystified*.

User guide [SLVU323](#), *TPS727xxYFF EVM*

User guide [SLVU325](#), *TPS727xxDSE EVM*

#### 11.1.2 Device Nomenclature

**Table 1. Device Nomenclature<sup>(1)</sup>**

PRODUCT	V <sub>OUT</sub> <sup>(2)</sup>
TPS727xxx yyy z	<p>XXX is the nominal output voltage.            YYY is package designator.            Z is package tape and reel quantity (R = 3000, T = 250).</p>

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or visit the device product folder at [www.ti.com](http://www.ti.com).
- (2) Output voltages from 0.9 V to 5.0 V in 50-mV increments are available through the use of innovative factory EEPROM programming; minimum order quantities may apply. Contact factory for details and availability.

### 11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.3 Trademarks

E2E is a trademark of Texas Instruments.

Bluetooth is a registered trademark of Bluetooth SIG.

Zigbee is a registered trademark of Zigbee Alliance.

All other trademarks are the property of their respective owners.

### 11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

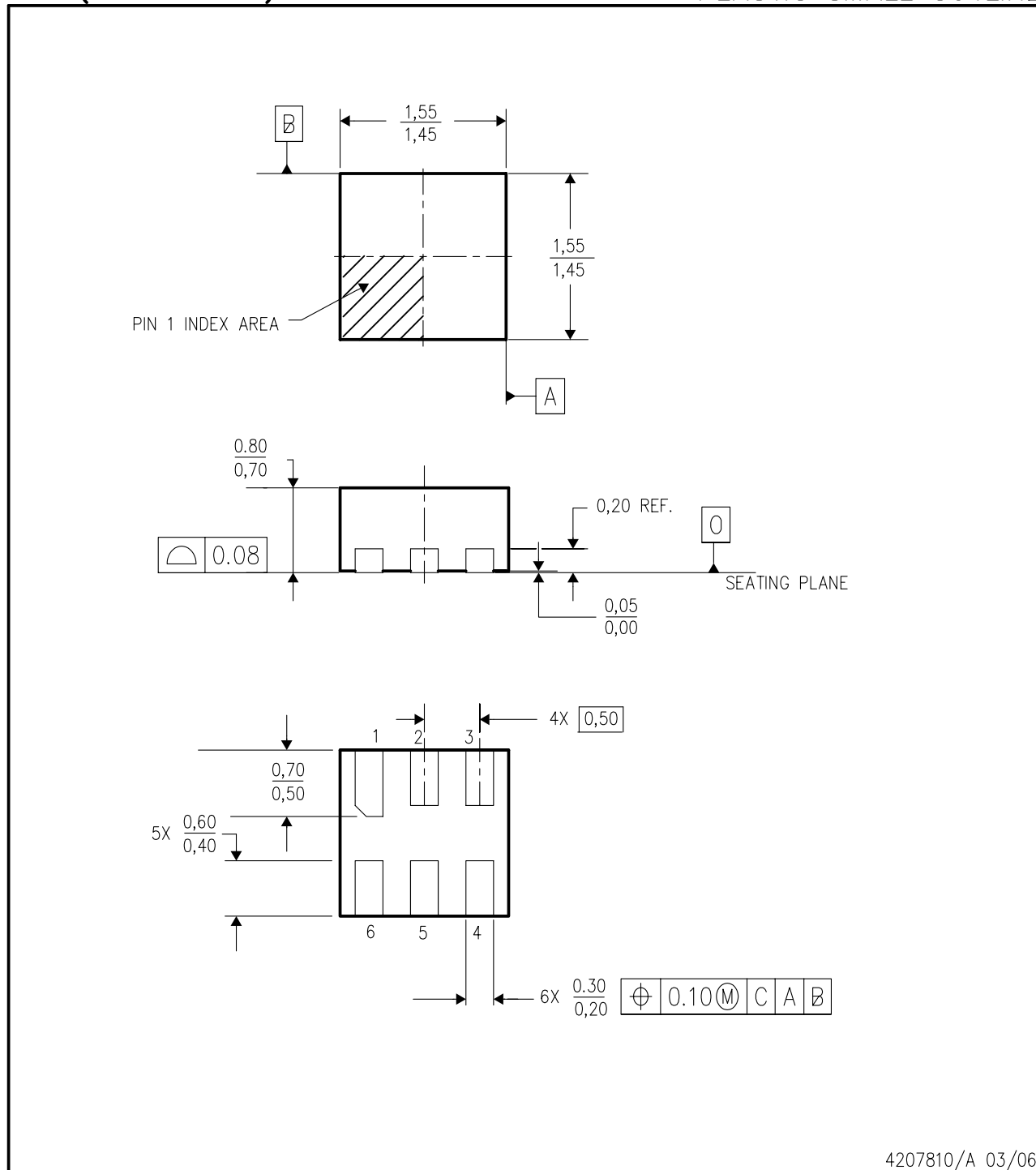
## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**MECHANICAL DATA**

**DSE (S-PDSO-N6)**

**PLASTIC SMALL OUTLINE**

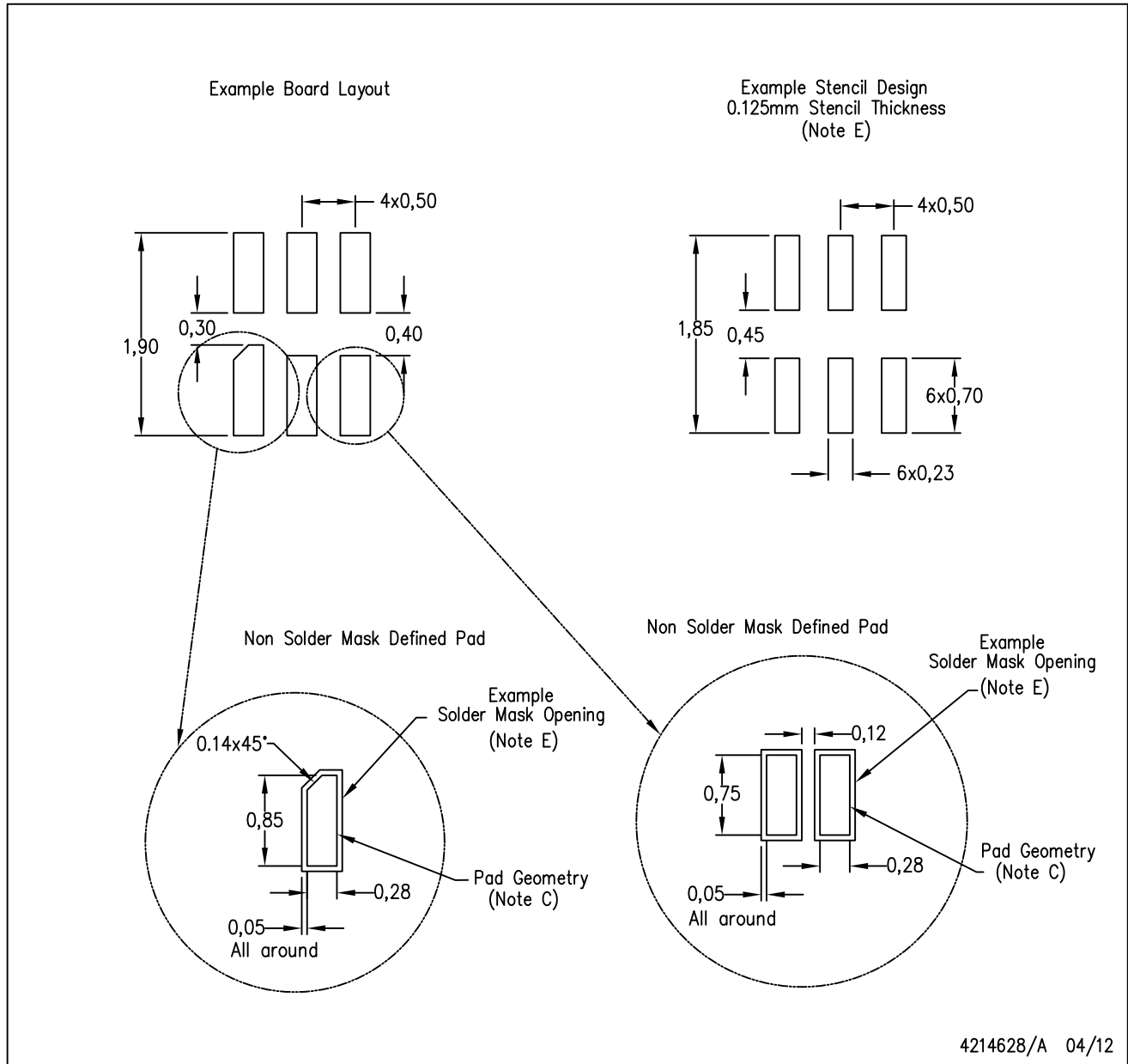


- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Small Outline No-Lead (SON) package configuration.
  - D. This package is lead-free.

LAND PATTERN DATA

DSE (S-PWSON-N6)

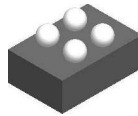
PLASTIC SMALL OUTLINE NO-LEAD



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - Customers should contact their board fabrication site for solder mask tolerances.

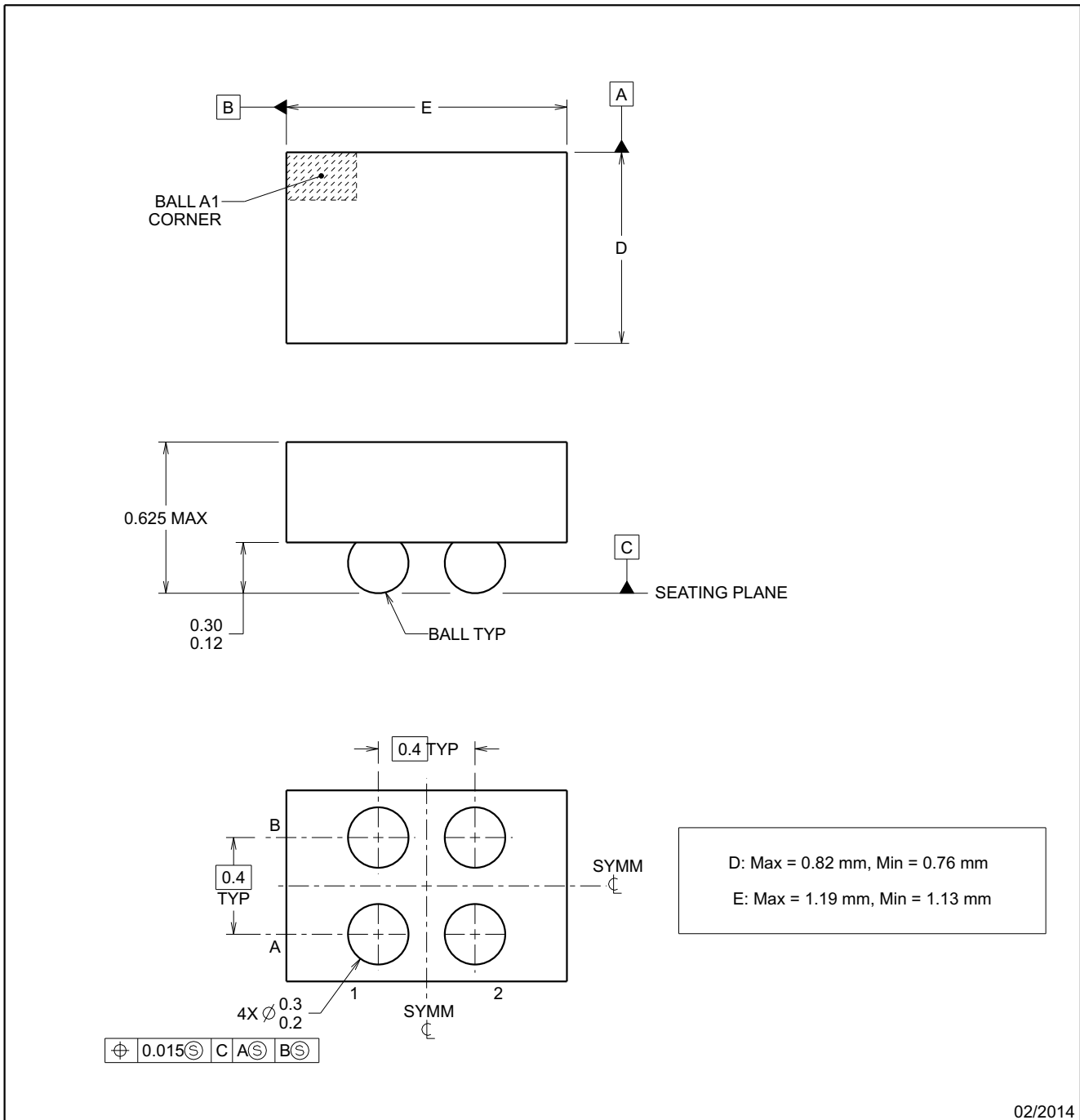


TPS727xxYFF  
YFF0004



PACKAGE OUTLINE  
DSBGA - 0.625 mm max height

DIE SIZE BALL GRID ARRAY



02/2014

NOTES:

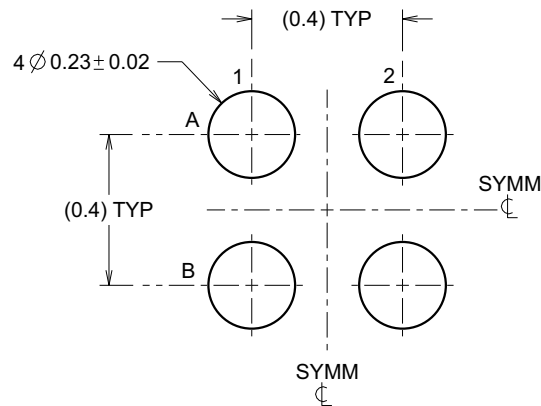
NanoFree Is a trademark of Texas Instruments.

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. NanoFree™ package configuration.

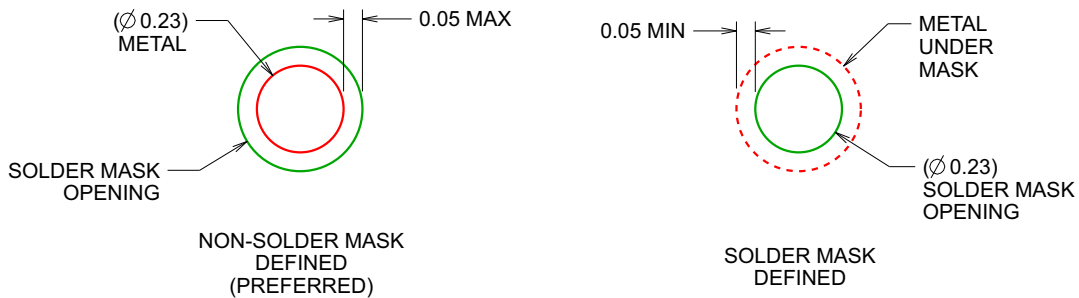
**TPS727xxYFF**  
**YFF0004**

**EXAMPLE BOARD LAYOUT**  
**DSBGA - 0.625 mm max height**

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:50X



SOLDER MASK DETAILS  
NOT TO SCALE

02/2014

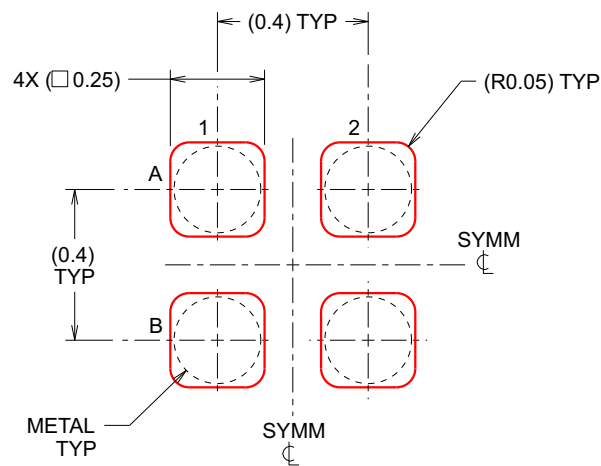
NOTES: (continued)

- 4. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. Refer to Texas Instruments Literature No. SBVA017 ([www.ti.com/lit/sbva017](http://www.ti.com/lit/sbva017)).

TPS727xxYFF  
YFF0004

EXAMPLE STENCIL DESIGN  
DSBGA - 0.625 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:50X

02/2014

NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">TPS727105YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GA
TPS727105YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GA
<a href="#">TPS727105YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GA
TPS727105YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GA
<a href="#">TPS72710DSER</a>	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	UR
TPS72710DSER.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	UR
<a href="#">TPS72710DSET</a>	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	UR
TPS72710DSET.B	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	UR
<a href="#">TPS72711YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	QL
TPS72711YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	QL
<a href="#">TPS72711YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	QL
TPS72711YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	QL
<a href="#">TPS72715DSER</a>	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GS
TPS72715DSER.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GS
<a href="#">TPS72715DSET</a>	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GS
TPS72715DSET.B	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GS
<a href="#">TPS72715YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GS
TPS72715YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GS
<a href="#">TPS72715YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GS
TPS72715YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GS
<a href="#">TPS727185YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	RW
TPS727185YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	RW
<a href="#">TPS727185YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	RW
TPS727185YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	RW
<a href="#">TPS72718DSER</a>	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GT
TPS72718DSER.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GT
TPS72718DSERG4	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	GT
TPS72718DSERG4.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	GT
<a href="#">TPS72718DSET</a>	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GT

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS72718DSET.B	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GT
<a href="#">TPS72718YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GT
TPS72718YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GT
<a href="#">TPS72718YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GT
TPS72718YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GT
<a href="#">TPS72719DSER</a>	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	CB
TPS72719DSER.B	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	CB
<a href="#">TPS72719DSET</a>	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	CB
TPS72719DSET.B	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	CB
TPS72719DSETG4.B	Active	Production	WSO (DSE)   6	250   SMALL T&R	-	Call TI	Call TI	-40 to 125	
<a href="#">TPS72719YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	AA
TPS72719YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	AA
<a href="#">TPS72719YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	AA
TPS72719YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	AA
<a href="#">TPS72725DSER</a>	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QA
TPS72725DSER.B	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QA
<a href="#">TPS72725DSET</a>	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QA
TPS72725DSET.B	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QA
<a href="#">TPS72727DSER</a>	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	TS
TPS72727DSER.B	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	TS
<a href="#">TPS72727DSET</a>	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	TS
TPS72727DSET.B	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	TS
<a href="#">TPS727285DSER</a>	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QK
TPS727285DSER.B	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QK
<a href="#">TPS727285DSET</a>	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QK
TPS727285DSET.B	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QK
TPS727285DSETG4.B	Active	Production	WSO (DSE)   6	250   SMALL T&R	-	Call TI	Call TI	-40 to 125	
<a href="#">TPS72728DSER</a>	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GU
TPS72728DSER.B	Active	Production	WSO (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GU
TPS72728DSERG4.B	Active	Production	WSO (DSE)   6	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
<a href="#">TPS72728DSET</a>	Active	Production	WSO (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GU

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS72728DSET.B	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	GU
<a href="#">TPS72728YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GU
TPS72728YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GU
<a href="#">TPS72728YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GU
TPS72728YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	GU
<a href="#">TPS72730DSE</a>	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QB
TPS72730DSE.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QB
<a href="#">TPS72730DSET</a>	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QB
TPS72730DSET.B	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QB
TPS72730DSETG4	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	QB
TPS72730DSETG4.B	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	QB
<a href="#">TPS72730YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZZ
TPS72730YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZZ
<a href="#">TPS72730YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZZ
TPS72730YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZZ
<a href="#">TPS72733DSE</a>	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QC
TPS72733DSE.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QC
TPS72733DSE.G4	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	QC
TPS72733DSE.G4.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	QC
<a href="#">TPS72733DSET</a>	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QC
TPS72733DSET.B	Active	Production	WSON (DSE)   6	250   SMALL T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	QC
<a href="#">TPS72733YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZY
TPS72733YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZY
<a href="#">TPS72733YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZY
TPS72733YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	ZY
<a href="#">TPS72748DSE</a>	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	KA
TPS72748DSE.B	Active	Production	WSON (DSE)   6	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	KA
<a href="#">TPS72748YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	EY
TPS72748YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	EY
<a href="#">TPS72748YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	EY
TPS72748YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	EY

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">TPS72750YFFR</a>	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	CA
TPS72750YFFR.B	Active	Production	DSBGA (YFF)   4	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	CA
<a href="#">TPS72750YFFT</a>	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	CA
TPS72750YFFT.B	Active	Production	DSBGA (YFF)   4	250   SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 125	CA

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS727105YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS727105YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72710DSE	WSO	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72710DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72710DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72710DSET	WSO	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72711YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72711YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72715DSE	WSO	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72715DSET	WSO	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72715YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS72715YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS727185YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS727185YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72718DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72718DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2



Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS72718DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72718YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS72718YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS72719DSE	WSO	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72719DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72719DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72719DSET	WSO	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72719YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72719YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72725DSE	WSO	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72725DSET	WSO	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72727DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72727DSE	WSO	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72727DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72727DSET	WSO	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS727285DSE	WSO	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS727285DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS727285DSET	WSO	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS727285DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72728DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72728DSE	WSO	DSE	6	3000	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72728DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72728DSET	WSO	DSE	6	250	179.0	8.4	1.8	1.8	1.0	4.0	8.0	Q2
TPS72728YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS72728YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS72730DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72730DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72730DSETG4	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72730YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72730YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72733DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72733DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72733DSET	WSO	DSE	6	250	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72733YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72733YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72748DSE	WSO	DSE	6	3000	178.0	8.4	1.7	1.7	0.95	4.0	8.0	Q2
TPS72748YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS72748YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q2
TPS72750YFFR	DSBGA	YFF	4	3000	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1
TPS72750YFFT	DSBGA	YFF	4	250	180.0	8.4	0.89	1.26	0.69	4.0	8.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS727105YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS727105YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72710DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS72710DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72710DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72710DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS72711YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72711YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72715DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS72715DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS72715YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72715YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS727185YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS727185YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72718DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72718DSERG4	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72718DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72718YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS72718YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72719DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS72719DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72719DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72719DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS72719YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72719YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72725DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS72725DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS72727DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72727DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS72727DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72727DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS727285DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS727285DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS727285DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS727285DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72728DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72728DSER	WSON	DSE	6	3000	200.0	183.0	25.0
TPS72728DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72728DSET	WSON	DSE	6	250	200.0	183.0	25.0
TPS72728YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72728YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72730DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72730DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72730DSETG4	WSON	DSE	6	250	205.0	200.0	33.0
TPS72730YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72730YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72733DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72733DSERG4	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72733DSET	WSON	DSE	6	250	205.0	200.0	33.0
TPS72733YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72733YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72748DSER	WSON	DSE	6	3000	205.0	200.0	33.0
TPS72748YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72748YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0
TPS72750YFFR	DSBGA	YFF	4	3000	182.0	182.0	20.0
TPS72750YFFT	DSBGA	YFF	4	250	182.0	182.0	20.0

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